















NOTES:

01

2 DIMENSIONING & TOLERANCING PER ANSI . Y14.5M - 1982.

3 "T" IS A REFERENCE DATUM.

"D" & "E" ARE REFERENCE DATUMS AND DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS, BUT DOES INCLUDE MOLD MISMATCH AND ARE MEASURED AT THE MOLD PARTING LINE. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED .006 INCHES PER SIDE.

5 "L" IS THE LENGTH OF TERMINAL FOR SOLDERING TO A SUBSTRATE.

TERMINAL POSITIONS ARE SHOWN FOR REFERENCE ONLY.

8 FORMED LEADS SHALL BE PLANAR WITH RESPECT TO ONE ANOTHER WITHIN .003 INCHES AT SEATING PLANE. CONTROLLING DIMENSION: INCHES.

THESE DIMENSIONS APPLY TO THE FLAT SECTION
OF THE LEAD BETWEEN .005 INCHES AND .010 INCHES
FROM THE LEAD TIPS.

 THIS PART IS COMPLIANT WITH JEDEC SPECIFICATION MO-118, VARIATIONS AA, AB, EXCEPT CHAMFER DIMENSION h. JEDEC SPECIFICATION FOR h IS .015"/.025".

S Y M B		N O		
0 L	MIN. NOM. MAX.		TE	
Α	.095	.102	.110	
A ₁	.008	.012	.016	
A ₂	.088	.090	.092	
b	.008	.010	.0135	
b ₁	.008	.010	.012	
С	.005	-	.010	
C 1	.005	.006	.0085	
D	.620	.625	.630	
E	.292	.292 .296		
е	.025 BSC			
Н	.400	.400 .406 .410		
h	.010	.013	.016	
L	.024	.032	.040	5
Х	.085	.093	.100	
coc	0°	5°	8°	

THIS TABLE	IN
INCHES	

S Y M B	COMMON DIMENSIONS			N O	
O L	MIN.	MIN. NOM. MAX.		T E	
Α	2.41	2.59	2.79		
Αı	0.20	0.31	0.41		
A ₂	2.24	2.29	2.34		
b	0.203	0.254	0.343		
b ₁	0.203	0.254	0.305		
С	0.127	-	0.254		
C 1	0.127	0.152	0.216		
D	15.75	15.88	16.00		
Е	7.42	7.42 7.52 7.59			
е		0.635 BSC			
Н	10.16	10.31	10.41		
h	0.25	0.33	0.41		
L	0.61	0.81	1.02	5	
Х	2.16	2.36	2.54		
coc	0°	5°	8°		

THIS TABLE IN MILLIMETERS

11189

12/02/04

	SIMTEK CORPORATION
—)	

Show correct orientation of Pin 1 at lower left.

SIMTEK		Package Outline: 48 lead 300 mil SSOP						
Drawn By B Stephens		filename		DWG NO 40-05-015			REV 00	
Checked By D Still				ECN #: 10529			1 of 1	
REV	DES	CRIPTIC	ON		D/	ATE	EC	CN